Lattice Semiconductor Corporation - LFSC3GA115E-5FF1152C Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1152-BBGA, FCBGA
Supplier Device Package	1152-FCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga115e-5ff1152c

Modes of Operation

Each Slice is capable of four modes of operation: Logic, Ripple, RAM and ROM. Table 2-2 lists the modes and the capability of the Slice blocks.

Table 2-2. Slice Modes

	Logic	Ripple	RAM	ROM
PFU Slice	LUT 4x2 or LUT 5x1	2-bit Arithmetic Unit	SPR 16x2 DPR 16x2	ROM 16x2

Logic Mode

In this mode, the LUTs in each Slice are configured as combinatorial lookup tables. A LUT4 can have 16 possible input combinations. Any logic function with four inputs can be generated by programming this lookup table. Since there are two LUT4s per Slice, a LUT5 can be constructed within one Slice. Larger lookup tables such as LUT6, LUT7 and LUT8 can be constructed by concatenating other Slices in the PFU.

Ripple Mode

Ripple mode allows the efficient implementation of small arithmetic functions. In ripple mode, the following functions can be implemented by each Slice:

- Addition 2-bit
- Subtraction 2-bit
- Up counter 2-bit
- Down counter 2-bit
- Comparator functions of A and B inputs
  - A greater-than-or-equal-to B
  - A not-equal-to B
  - A less-than-or-equal-to B

Ripple Mode includes an optional configuration that performs arithmetic using fast carry chain methods. In this configuration (also referred to as CCU2 mode) two additional signals, Carry Generate and Carry Propagate, are generated on a per slice basis to allow fast arithmetic functions to be constructed by concatenating Slices.

RAM Mode

In this mode, distributed RAM can be constructed using each LUT block as a 16x1-bit memory. Through the combination of LUTs and Slices, a variety of different memories can be constructed.

The Lattice design tools support the creation of a variety of different size memories. Where appropriate, the software will construct these using distributed memory primitives that represent the capabilities of the Slice. Table 2-3 shows the number of Slices required to implement different distributed RAM primitives. Dual port memories involve the pairing of two Slices, one Slice functions as the read-write port. The other companion Slice supports the read-only port. For more information on RAM mode, please see details of additional technical documentation at the end of this data sheet.

Table 2-3. Number of Slices Required For Implementing Distributed RAM

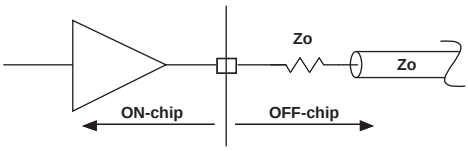
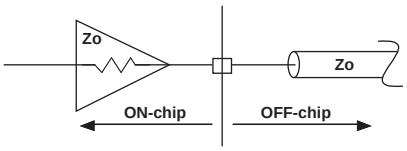
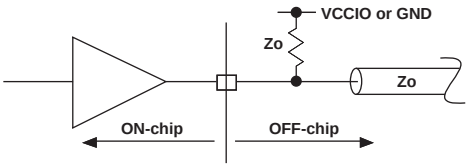
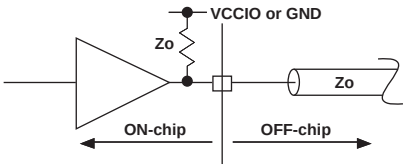
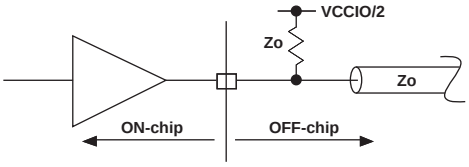
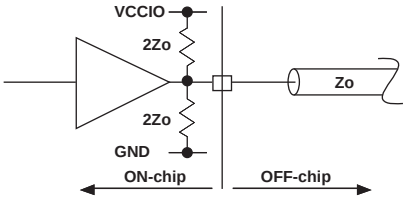
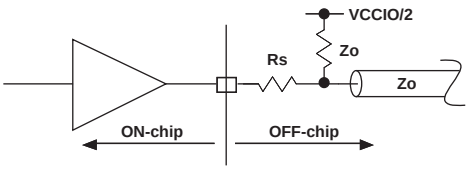
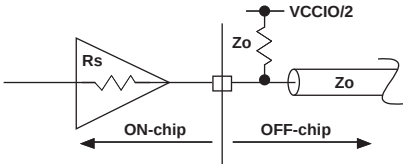
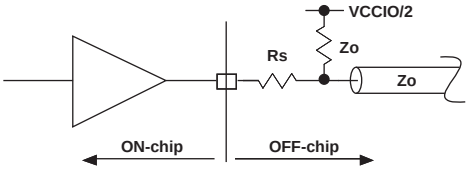
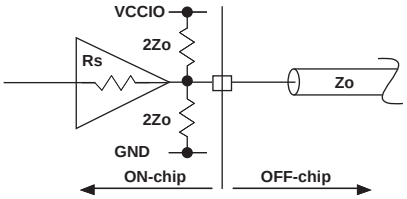
	SPR16x2	DPR16x2
Number of Slices	1	2

Note: SPR = Single Port RAM, DPR = Dual Port RAM

ROM Mode

The ROM mode uses the same principal as the RAM modes, but without the Write port. Pre-loading is accomplished through the programming interface during configuration.

Figure 2-27. Output Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Series termination (controlled output impedance)		
Parallel termination to V_{CCIO}, or parallel driving end		
Parallel termination to $V_{CCIO}/2$ driving end		
Combined series + parallel termination to $V_{CCIO}/2$ at driving end (only series termination moved on-chip)		
Combined series + parallel to $V_{CCIO}/2$ driving end		

PURESPEED I/O Single-Ended DC Electrical Characteristics

Over Recommended Operating Conditions

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL} (mA)	I_{OH} (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 33	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVTTL	-0.3	0.8	2	3.465	0.4	2.4	24, 16, 8	-24, -16, -8
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 25	-0.3	0.7	1.7	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 18	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 15	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.4	VCCIO - 0.4	16, 12, 8, 4	-16, -12, -8, -4
					0.2	VCCIO - 0.2	0.1	-0.1
LVCMOS 12	-0.3	0.35VCCIO	0.65VCCIO	2.65	0.3	VCCIO - 0.3	12, 8, 4, 2	-12, -8, -4, -2
					0.2	VCCIO - 0.2	0.1	-0.1
PCIX15	-0.3	0.3VCCIO	0.5VCCIO	1.5	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCI33	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
PCIX33	-0.3	0.35VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
AGP-1X, AGP-2X	-0.3	0.3VCCIO	0.5VCCIO	3.465	0.1VCCIO	0.9VCCIO	1.5	-0.5
SSTL3_I	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.7	VCCIO - 1.1	8	-8
SSTS3_I OST[2]	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 1.3	8	-8
SSTL3_II	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.5	VCCIO - 0.9	16	-16
SSTL3_II OST[2]	-0.3	VREF - 0.2	VREF + 0.2	3.465	0.9	VCCIO - 0.13	16	-16
SSTL2_I	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.54	VCCIO - 0.62	7.6	-7.6
SSTL2_I OST[2]	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	7.6	-7.6
SSTL2_II	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.35	VCCIO - 0.43	15.2	-15.2
SSTL2_II OST[2]	-0.3	VREF - 0.18	VREF + 0.18	2.65	0.73	VCCIO - 0.81	15.2	-15.2
SSTL18_I	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
SSTL18_II	-0.3	VREF - 0.125	VREF + 0.125	2.65	0.28	VCCIO - 0.28	13.4	-13.4
HSTL15_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	8	-8
HSTL15_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	16	-16
HSTL15_III[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL15_IV[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_I	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	9.6	-9.6
HSTL18_II	-0.3	VREF - 0.1	VREF + 0.1	2.65	0.4	VCCIO - 0.4	19.2	-19.2
HSTL18_III[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
HSTL18_IV[1]	-0.3	VREF - 0.1	VREF + 0.1	2.65	N/A	N/A	N/A	N/A
GTL12[1], GTLPLUS15[1]	-0.3	VREF - 0.2	VREF + 0.2	N/A	N/A	N/A	N/A	N/A

1. Input only.
2. Input with on-chip series termination.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
RESETN		Reset. (Also sent to general routing). During configuration it resets the configuration state machine. After configuration this pin can perform the global set/reset (GSR) functions or can be used as a general input pin.
CFGIRQN	O	MPI Interrupt request active low signal is controlled by system bus interrupt controller and may be sourced from any bus error or MPI configuration error. It can be connected to one of MPC860 IRQ pins.
TSALLN	I	Tristates all I/O.
Configuration Pads (User I/O if not used. Used during sysCONFIG.)		
HDC/SI	O	High During Configuration is output high until configuration is complete. It is used as a control output, indicating that configuration is not complete. For SPI modes, this pin is used to download the read command and initial read address into the Flash memory device on the falling edge of SCK. This pin will be connected to SI of the memory. If the SPI mode is used, the 8-bit instruction code 0x03 will be downloaded followed by a 24-bit starting address of 0x000000 or a non-zero stat address for partial reconfiguration. If the SPIX mode has been selected, the 8-bit instruction captured on D[7:0] at power-up will be shifted in and followed by a 32-bit starting address of 0x000000.
LDCN/SCS	O	Low During Configuration is output low until configuration is complete. It is used as a control output, indicating that configuration is not complete. For SPI modes, this is an active low chip select for Flash memories. It will go active after INITN goes high but before SCK begins. During power up LDCN will be low. Once INITN goes high, LDCN will go high for 100ns-200ns after which time it will go back low and configuration can begin. During the 100ns-200ns period, the read instruction will be latched for SPIX mode.
DOUT	O	Serial data output that can drive the D0/DIN of daisy-chained slave devices. The data-stream from this output will propagate preamble bits of the bitstream to daisy-chained devices. Data out on DOUT changes on the rising edge of CCLK.
QOUT/CEON	O	During daisy-chaining configuration, QOUT is the serial data output that can drive the D0/DIN of daisy-chained slave devices that do not propagate preamble bits. Data out on QOUT changes on the rising edge of CCLK. During parallel-chaining configuration, active low CEON enables the cascaded slave device to receive bitstream data.
RDN	I	Used in the asynchronous peripheral configuration mode. A low on RDN changes D[7:3] into status outputs. WRN and RDN should not be used simultaneously. If they are, the write strobe overrides.
WRN	I	When the FPGA is selected, a low on the write strobe, WRN, loads the data on D[7:0] inputs into an internal data buffer.
CS0N CS1	I	Used in the asynchronous peripheral, slave parallel and MPI modes. The FPGA is selected when CS0N is low and CS1 is high. During configuration, a pull-up is enabled on both except with MPI DMA access control.
A[21:0]	I/O	In master parallel mode, A[21:0] is an output and will address the configuration EPROMs up to 4 MB space. For MPI configuration mode, A[17:0] will be the MPI address MPI_ADDR[31:14], A[19:18] will be the transfer size and A[21:20] will be the burst mode and burst in process.

LFSC/M15 Logic Signal Connections: 256 fpBGA[1,2] (Cont.)

Ball Number	LFSC/M15		
	Ball Function	VCCIO Bank	Dual Function
F14	PR17A	2	URC_DLLT_IN_C/URC_DLLT_FB_D
E15	PR15B	2	URC_PLLC_IN_A/URC_PLLC_FB_B
E14	PR15A	2	URC_PLLT_IN_A/URC_PLLT_FB_B
D9	VCCJ	-	
C16	TDO	-	TDO
B15	TMS	-	
B16	TCK	-	
E13	TDI	-	
C14	PROGRAMN	1	
C15	CCLK	1	
A15	PT43D	1	HDC/SI
A14	PT43C	1	LDCN/SCS
B14	PT41A	1	CS1
E12	PT39B	1	CS0N
D13	PT39A	1	RDN
D12	PT37D	1	WRN
E10	PT37C	1	D7
C11	PT37B	1	D6
D10	PT37A	1	D5
A13	PT36D	1	D4
B12	PT36C	1	D3
A12	PT35B	1	D2
C12	PT35A	1	D1
A11	PT33B	1	D0
B11	PT33A	1	QOUT/CEON
E9	PT32D	1	VREF2_1
E8	PT32B	1	DOUT
D8	PT28C	1	BUSYN/RCLK/SCK
A10	PT27B	1	PCLKC1_0
C10	PT27A	1	PCLKT1_0
E7	PT21C	1	VREF1_1
C9	A_VDDIB3_L	-	
A9	A_HDINP3_L	-	PCS 360 CH 3 IN P
B9	A_HDINN3_L	-	PCS 360 CH 3 IN N
A8	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
B8	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
C8	A_VDDOB3_L	-	
B7	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
C7	A_VDDOB2_L	-	
A7	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
B6	A_HDINN2_L	-	PCS 360 CH 2 IN N
A6	A_HDINP2_L	-	PCS 360 CH 2 IN P
C6	A_VDDIB2_L	-	

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
N17	GND	-		GND	-	
N18	GND	-		GND	-	
N19	GND	-		GND	-	
N20	GND	-		GND	-	
P11	GND	-		GND	-	
P12	GND	-		GND	-	
P13	GND	-		GND	-	
P14	GND	-		GND	-	
P15	GND	-		GND	-	
P16	GND	-		GND	-	
P17	GND	-		GND	-	
P18	GND	-		GND	-	
P19	GND	-		GND	-	
P20	GND	-		GND	-	
R10	GND	-		GND	-	
R11	GND	-		GND	-	
R12	GND	-		GND	-	
R13	GND	-		GND	-	
R14	GND	-		GND	-	
R15	GND	-		GND	-	
R16	GND	-		GND	-	
R17	GND	-		GND	-	
R18	GND	-		GND	-	
R19	GND	-		GND	-	
R20	GND	-		GND	-	
R21	GND	-		GND	-	
T10	GND	-		GND	-	
T11	GND	-		GND	-	
T12	GND	-		GND	-	
T13	GND	-		GND	-	
T14	GND	-		GND	-	
T15	GND	-		GND	-	
T16	GND	-		GND	-	
T17	GND	-		GND	-	
T18	GND	-		GND	-	
T19	GND	-		GND	-	
T20	GND	-		GND	-	
T21	GND	-		GND	-	
U11	GND	-		GND	-	
U12	GND	-		GND	-	
U13	GND	-		GND	-	
U14	GND	-		GND	-	
U15	GND	-		GND	-	
U16	GND	-		GND	-	
U17	GND	-		GND	-	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P17	VCC	-		VCC	-	
P19	VCC	-		VCC	-	
R13	VCC	-		VCC	-	
R15	VCC	-		VCC	-	
R18	VCC	-		VCC	-	
R20	VCC	-		VCC	-	
T13	VCC	-		VCC	-	
T14	VCC	-		VCC	-	
T16	VCC	-		VCC	-	
T17	VCC	-		VCC	-	
T19	VCC	-		VCC	-	
T20	VCC	-		VCC	-	
U13	VCC	-		VCC	-	
U14	VCC	-		VCC	-	
U16	VCC	-		VCC	-	
U17	VCC	-		VCC	-	
U19	VCC	-		VCC	-	
U20	VCC	-		VCC	-	
V13	VCC	-		VCC	-	
V15	VCC	-		VCC	-	
V18	VCC	-		VCC	-	
V20	VCC	-		VCC	-	
W14	VCC	-		VCC	-	
W16	VCC	-		VCC	-	
W17	VCC	-		VCC	-	
W19	VCC	-		VCC	-	
Y13	VCC	-		VCC	-	
Y15	VCC	-		VCC	-	
Y16	VCC	-		VCC	-	
Y17	VCC	-		VCC	-	
Y18	VCC	-		VCC	-	
Y20	VCC	-		VCC	-	
C17	VCCIO1	-		VCCIO1	-	
D16	VCCIO1	-		VCCIO1	-	
F15	VCCIO1	-		VCCIO1	-	
F24	VCCIO1	-		VCCIO1	-	
G18	VCCIO1	-		VCCIO1	-	
G9	VCCIO1	-		VCCIO1	-	
J11	VCCIO1	-		VCCIO1	-	
J19	VCCIO1	-		VCCIO1	-	
K14	VCCIO1	-		VCCIO1	-	
K22	VCCIO1	-		VCCIO1	-	
G4	VCCIO2	-		VCCIO2	-	
J7	VCCIO2	-		VCCIO2	-	
K3	VCCIO2	-		VCCIO2	-	
L10	VCCIO2	-		VCCIO2	-	
M6	VCCIO2	-		VCCIO2	-	
N4	VCCIO2	-		VCCIO2	-	
P9	VCCIO2	-		VCCIO2	-	
R7	VCCIO2	-		VCCIO2	-	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AJ9	PB78C	4		PB117C	4	
AJ8	PB78D	4		PB117D	4	
AP3	PB79A	4		PB119A	4	
AN3	PB79B	4		PB119B	4	
AF10	PB79C	4		PB119C	4	
AE10	PB79D	4		PB119D	4	
AL7	PB81A	4		PB121A	4	
AL6	PB81B	4		PB121B	4	
AK7	PB81C	4		PB121C	4	
AK6	PB81D	4		PB121D	4	
AN5	PB82A	4		PB123A	4	
AN4	PB82B	4		PB123B	4	
AH9	PB82C	4	VREF1_4	PB123C	4	VREF1_4
AH8	PB82D	4		PB123D	4	
AM3	PB83A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D	PB124A	4	LRC_DLLT_IN_C/LRC_DLLT_FB_D
AM4	PB83B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D	PB124B	4	LRC_DLLC_IN_C/LRC_DLLC_FB_D
AG9	PB83C	4		PB124C	4	
AG8	PB83D	4		PB124D	4	
AN2	PB85A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B	PB125A	4	LRC_PLLT_IN_A/LRC_PLLT_FB_B
AM2	PB85B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B	PB125B	4	LRC_PLLC_IN_A/LRC_PLLC_FB_B
AJ6	PB85C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C	PB125C	4	LRC_DLLT_IN_D/LRC_DLLT_FB_C
AH6	PB85D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C	PB125D	4	LRC_DLLC_IN_D/LRC_DLLC_FB_C
AF7	PROBE_VCC	-		PROBE_VCC	-	
AF8	PROBE_GND	-		PROBE_GND	-	
AG7	PR71D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A	PR95D	3	LRC_PLLC_IN_B/LRC_PLLC_FB_A
AG6	PR71C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A	PR95C	3	LRC_PLLT_IN_B/LRC_PLLT_FB_A
AL4	PR71B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E	PR95B	3	LRC_DLLC_IN_F/LRC_DLLC_FB_E
AL3	PR71A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E	PR95A	3	LRC_DLLT_IN_F/LRC_DLLT_FB_E
AD10	PR70D	3		PR94D	3	
AD9	PR70C	3		PR94C	3	
AH4	PR70B	3		PR94B	3	
AJ4	PR70A	3		PR94A	3	
AK5	PR69D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F	PR93D	3	LRC_DLLC_IN_E/LRC_DLLC_FB_F
AJ5	PR69C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F	PR93C	3	LRC_DLLT_IN_E/LRC_DLLT_FB_F
AM1	PR69B	3		PR93B	3	
AL1	PR69A	3		PR93A	3	
AH5	PR67D	3		PR91D	3	
AG5	PR67C	3		PR91C	3	
AL2	PR67B	3		PR91B	3	
AK2	PR67A	3		PR91A	3	
AB9	PR66D	3		PR90D	3	
AC9	PR66C	3		PR90C	3	
AH1	PR66B	3		PR90B	3	
AG1	PR66A	3		PR90A	3	
AE8	PR65D	3	VREF2_3	PR89D	3	VREF2_3

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
G27	A_REFCLKP_L	-	
H27	A_REFCLKN_L	-	
H25	VCC12	-	
H26	RESP_ULC	-	
B33	RESETN	1	
C34	TSALLN	1	
D34	DONE	1	
C33	INITN	1	
J27	M0	1	
K27	M1	1	
M26	M2	1	
L26	M3	1	
F30	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
G30	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
H28	PL15C	7	
J28	PL15D	7	
F31	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
G31	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
N25	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
P25	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
D33	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
E33	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
H29	PL18C	7	
J29	PL18D	7	VREF2_7
F32	PL19A	7	
G32	PL19B	7	
P26	PL19C	7	
N26	PL19D	7	
H30	PL26A	7	
J30	PL26B	7	
L28	PL26C	7	
M28	PL26D	7	
J31	PL43A	7	
K31	PL43B	7	
L27	PL43C	7	VREF1_7
M27	PL43D	7	DIFFR_7
J32	PL45A	7	
K32	PL45B	7	
L29	PL45C	7	
M29	PL45D	7	
H33	PL47A	7	
J33	PL47B	7	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
L5	PR38B	2	
K5	PR38A	2	
G2	PR34B	2	
F2	PR34A	2	
F1	PR30B	2	
E1	PR30A	2	
A2	GND	-	
A33	GND	-	
AA15	GND	-	
AA20	GND	-	
AA32	GND	-	
AA4	GND	-	
AB28	GND	-	
AB6	GND	-	
AC11	GND	-	
AC18	GND	-	
AC25	GND	-	
AD23	GND	-	
AD3	GND	-	
AD31	GND	-	
AE12	GND	-	
AE15	GND	-	
AE29	GND	-	
AE7	GND	-	
AE9	GND	-	
AF20	GND	-	
AF26	GND	-	
AG32	GND	-	
AG4	GND	-	
AH13	GND	-	
AH19	GND	-	
AH25	GND	-	
AH7	GND	-	
AJ10	GND	-	
AJ16	GND	-	
AJ22	GND	-	
AJ28	GND	-	
AK3	GND	-	
AK31	GND	-	
AL11	GND	-	
AL17	GND	-	
AL21	GND	-	
AL27	GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
K26	GND	-	
K28	GND	-	
K6	GND	-	
K9	GND	-	
L12	GND	-	
L32	GND	-	
L4	GND	-	
M10	GND	-	
M17	GND	-	
M24	GND	-	
N29	GND	-	
N7	GND	-	
P15	GND	-	
P20	GND	-	
P3	GND	-	
P31	GND	-	
R10	GND	-	
R14	GND	-	
R16	GND	-	
R19	GND	-	
R21	GND	-	
R26	GND	-	
T15	GND	-	
T17	GND	-	
T18	GND	-	
T20	GND	-	
T28	GND	-	
T6	GND	-	
U16	GND	-	
U19	GND	-	
U23	GND	-	
U32	GND	-	
U4	GND	-	
V12	GND	-	
V16	GND	-	
V19	GND	-	
V3	GND	-	
V31	GND	-	
W15	GND	-	
W17	GND	-	
W18	GND	-	
W20	GND	-	
W29	GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2]

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
G34	A_REFCLKP_L	-		A_REFCLKP_L	-	
H34	A_REFCLKN_L	-		A_REFCLKN_L	-	
N30	VCC12	-		VCC12	-	
H33	RESP_ULC	-		RESP_ULC	-	
P25	RESETN	1		RESETN	1	
P26	TSALLN	1		TSALLN	1	
P31	DONE	1		DONE	1	
P23	INITN	1		INITN	1	
P30	M0	1		M0	1	
P22	M1	1		M1	1	
P24	M2	1		M2	1	
R22	M3	1		M3	1	
J37	PL16A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B	PL15A	7	ULC_PLLT_IN_A/ULC_PLLT_FB_B
J38	PL16B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B	PL15B	7	ULC_PLLC_IN_A/ULC_PLLC_FB_B
P32	PL16C	7		PL15C	7	
R32	PL16D	7		PL15D	7	
G40	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D	PL17A	7	ULC_DLLT_IN_C/ULC_DLLT_FB_D
H40	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D	PL17B	7	ULC_DLLC_IN_C/ULC_DLLC_FB_D
N33	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A	PL17C	7	ULC_PLLT_IN_B/ULC_PLLT_FB_A
P33	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A	PL17D	7	ULC_PLLC_IN_B/ULC_PLLC_FB_A
G41	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C	PL18A	7	ULC_DLLT_IN_D/ULC_DLLT_FB_C
H41	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C	PL18B	7	ULC_DLLC_IN_D/ULC_DLLC_FB_C
T29	PL18C	7		PL18C	7	
U29	PL18D	7	VREF2_7	PL18D	7	VREF2_7
G42	PL20A	7		PL19A	7	
H42	PL20B	7		PL19B	7	
M34	PL20C	7		PL19C	7	
M35	PL20D	7		PL19D	7	
K37	PL21A	7		PL26A	7	
L37	PL21B	7		PL26B	7	
N34	PL21C	7		PL26C	7	
P34	PL21D	7		PL26D	7	
K38	PL22A	7		PL30A	7	
L38	PL22B	7		PL30B	7	
T33	PL22C	7		PL30C	7	
R33	PL22D	7		PL30D	7	
J41	PL24A	7		PL34A	7	
K41	PL24B	7		PL34B	7	
U31	PL24C	7		PL34C	7	
V31	PL24D	7		PL34D	7	
K42	PL25A	7		PL38A	7	
J42	PL25B	7		PL38B	7	
J36	PL25C	7		PL38C	7	
K36	PL25D	7		PL38D	7	
N38	PL26A	7		PL40A	7	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AD33	PL59D	6		PL73D	6	
AA38	PL60A	6		PL74A	6	
AB38	PL60B	6		PL74B	6	
AC29	PL60C	6		PL74C	6	
AD29	PL60D	6		PL74D	6	
AA41	PL61A	6		PL75A	6	
AB41	PL61B	6		PL75B	6	
AC34	PL61C	6		PL75C	6	
AD34	PL61D	6		PL75D	6	
AA42	PL63A	6		PL77A	6	
AB42	PL63B	6		PL77B	6	
AC37	PL63C	6		PL77C	6	
AD37	PL63D	6		PL77D	6	
AC38	PL64A	6		PL78A	6	
AD38	PL64B	6		PL78B	6	
AD36	PL64C	6		PL78C	6	
AE36	PL64D	6		PL78D	6	
AC39	PL65A	6		PL79A	6	
AD39	PL65B	6		PL79B	6	
AD35	PL65C	6		PL79C	6	
AE35	PL65D	6		PL79D	6	
AC40	PL67A	6		PL81A	6	
AD40	PL67B	6		PL81B	6	
AE37	PL67C	6		PL81C	6	
AF37	PL67D	6		PL81D	6	
AC41	PL68A	6		PL82A	6	
AD41	PL68B	6		PL82B	6	
AE34	PL68C	6		PL82C	6	
AF34	PL68D	6		PL82D	6	
AC42	PL69A	6		PL83A	6	
AD42	PL69B	6		PL83B	6	
AE33	PL69C	6		PL83C	6	
AF33	PL69D	6		PL83D	6	
AE38	PL72A	6		PL86A	6	
AF38	PL72B	6		PL86B	6	
AE32	PL72C	6		PL86C	6	
AF32	PL72D	6		PL86D	6	
AE41	PL73A	6		PL87A	6	
AF41	PL73B	6		PL87B	6	
AE31	PL73C	6		PL87C	6	
AF31	PL73D	6		PL87D	6	
AE42	PL74A	6		PL88A	6	
AF42	PL74B	6		PL88B	6	
AG37	PL74C	6		PL88C	6	
AH37	PL74D	6		PL88D	6	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AY41	PB12A	5		PB13A	5	
BA41	PB12B	5		PB13B	5	
AT39	PB12C	5		PB13C	5	
AT38	PB12D	5		PB13D	5	
AV37	PB13A	5		PB15A	5	
AV36	PB13B	5		PB15B	5	
AM31	PB13C	5		PB15C	5	
AM32	PB13D	5		PB15D	5	
BA40	PB15A	5		PB16A	5	
BB40	PB15B	5		PB16B	5	
AM29	PB15C	5		PB16C	5	
AL29	PB15D	5		PB16D	5	
AY39	PB16A	5		PB17A	5	
AY38	PB16B	5		PB17B	5	
AN33	PB16C	5		PB17C	5	
AN32	PB16D	5		PB17D	5	
BA39	PB17A	5		PB19A	5	
BA38	PB17B	5		PB19B	5	
AT37	PB17C	5		PB19C	5	
AT36	PB17D	5		PB19D	5	
AW36	PB19A	5		PB20A	5	
AW35	PB19B	5		PB20B	5	
AM28	PB19C	5		PB20C	5	
AL28	PB19D	5		PB20D	5	
BB38	PB20A	5		PB21A	5	
BB39	PB20B	5		PB21B	5	
AR34	PB20C	5		PB21C	5	
AR33	PB20D	5		PB21D	5	
AV35	PB21A	5		PB23A	5	
AV34	PB21B	5		PB23B	5	
AT33	PB21C	5		PB23C	5	
AT34	PB21D	5		PB23D	5	
BA37	PB23A	5		PB25A	5	
BA36	PB23B	5		PB25B	5	
AP33	PB23C	5		PB25C	5	
AP32	PB23D	5		PB25D	5	
AY36	PB24A	5		PB26A	5	
AY35	PB24B	5		PB26B	5	
AN31	PB24C	5		PB26C	5	
AN30	PB24D	5		PB26D	5	
BB37	PB25A	5		PB27A	5	
BB36	PB25B	5		PB27B	5	
AP31	PB25C	5		PB27C	5	
AP30	PB25D	5		PB27D	5	
AV33	PB27A	5		PB29A	5	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V8	PR41C	2		PR55C	2	
T4	PR41B	2		PR55B	2	
U4	PR41A	2		PR55A	2	
V9	PR39D	2		PR53D	2	
U9	PR39C	2		PR53C	2	
V6	PR39B	2		PR53B	2	
U6	PR39A	2		PR53A	2	
AA12	PR38D	2		PR52D	2	
Y12	PR38C	2		PR52C	2	
P1	PR38B	2		PR52B	2	
N1	PR38A	2		PR52A	2	
T7	PR37D	2		PR51D	2	
R7	PR37C	2		PR51C	2	
T5	PR37B	2		PR51B	2	
R5	PR37A	2		PR51A	2	
U10	PR35D	2		PR49D	2	
V10	PR35C	2		PR49C	2	
P2	PR35B	2		PR49B	2	
N2	PR35A	2		PR49A	2	
T8	PR34D	2		PR48D	2	
R8	PR34C	2		PR48C	2	
N3	PR34B	2		PR48B	2	
P3	PR34A	2		PR48A	2	
M6	PR33D	2		PR47D	2	
M7	PR33C	2		PR47C	2	
T6	PR33B	2		PR47B	2	
R6	PR33A	2		PR47A	2	
V11	PR31D	2		PR45D	2	
U11	PR31C	2		PR45C	2	
M1	PR31B	2		PR45B	2	
L1	PR31A	2		PR45A	2	
Y14	PR30D	2		PR44D	2	
W14	PR30C	2		PR44C	2	
M2	PR30B	2		PR44B	2	
L2	PR30A	2		PR44A	2	
T9	PR29D	2	DIFFR_2	PR43D	2	DIFFR_2
R9	PR29C	2	VREF1_2	PR43C	2	VREF1_2
P4	PR29B	2		PR43B	2	
N4	PR29A	2		PR43A	2	
N7	PR26D	2		PR40D	2	
N8	PR26C	2		PR40C	2	
P5	PR26B	2		PR40B	2	
N5	PR26A	2		PR40A	2	
K7	PR25D	2		PR38D	2	
J7	PR25C	2		PR38C	2	

Industrial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA115E-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	115.2
LFSC3GA115E-6FF1152I	-6	Organic fcBGA	1152	IND	115.2
LFSC3GA115E-5FF1152I	-5	Organic fcBGA	1152	IND	115.2
LFSC3GA115E-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	115.2
LFSC3GA115E-6FF1704I	-6	Organic fcBGA	1704	IND	115.2
LFSC3GA115E-5FF1704I	-5	Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FC1152I[1]	-6	Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FC1152I[1]	-5	Ceramic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FF1152I	-6	Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-5FF1152I	-5	Organic fcBGA	1152	IND	115.2
LFSCM3GA115EP1-6FC1704I[1]	-6	Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FC1704I[1]	-5	Ceramic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-6FF1704I	-6	Organic fcBGA	1704	IND	115.2
LFSCM3GA115EP1-5FF1704I	-5	Organic fcBGA	1704	IND	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-7FFN1020C[1]	-7	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-6FFN1020C[1]	-6	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-5FFN1020C[1]	-5	Lead-Free Organic fcBGA	1020	COM	40.4
LFSC3GA40E-7FFAN1020C	-7	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-6FFAN1020C	-6	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-5FFAN1020C	-5	Lead-Free Organic fcBGA Revision 2	1020	COM	40.4
LFSC3GA40E-7FCN1152C[2]	-7	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-6FCN1152C[2]	-6	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-5FCN1152C[2]	-5	Lead-Free Ceramic fcBGA	1152	COM	40.4
LFSC3GA40E-7FFN1152C	-7	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	40.4
LFSC3GA40E-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA40EP1-7FFN1020C[1]	-7	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-6FFN1020C[1]	-6	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-5FFN1020C[1]	-5	Organic fcBGA	1020	COM	40.4
LFSCM3GA40EP1-7FFAN1020C	-7	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-6FFAN1020C	-6	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-5FFAN1020C	-5	Organic fcBGA Revision 2	1020	COM	40.4
LFSCM3GA40EP1-7FCN1152C[2]	-7	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FCN1152C[2]	-6	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FCN1152C[2]	-5	Ceramic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-7FFN1152C	-7	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-6FFN1152C	-6	Organic fcBGA	1152	COM	40.4
LFSCM3GA40EP1-5FFN1152C	-5	Organic fcBGA	1152	COM	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Commercial, Cont.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA115EP1-6FCN1152C[1]	-6	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FCN1152C[1]	-5	Lead-Free Ceramic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FFN1152C	-6	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-5FFN1152C	-5	Lead-Free Organic fcBGA	1152	COM	115.2
LFSCM3GA115EP1-6FCN1704C[1]	-6	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FCN1704C[1]	-5	Lead-Free Ceramic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-6FFN1704C	-6	Lead-Free Organic fcBGA	1704	COM	115.2
LFSCM3GA115EP1-5FFN1704C	-5	Lead-Free Organic fcBGA	1704	COM	115.2

1. Converted to organic flip-chip BGA package per PCN #01A-10.

LatticeSC/M Family Data Sheet Revision History

December 2011 **Data Sheet DS1004**

Date	Version	Section	Change Summary
February 2006	01.0	—	Initial release.
March 2006	01.1	Introduction	SC25 1020 I/O count changed to 476.
		Architecture	Changed ROM 16X4 to ROM 16X2.
			Changed “X2 or X4” to “DIV2 or DIV4”.
			Added Global Set/Reset Section.
		DC and Switching Characteristics	Added notes 5 and 6 to Recommended Operating Conditions table.
			Added Power Supply Ramp Rates table.
			Removed -5 and -6 speed grades from Typical Building Block Performance table.
			Added Input Delay Timing table.
			Added Synchronous GSR Timing table.
		Pinout Information	Expanded PROBE_VCC and PROBE_GND description.
			Removed A-RXREFCLKP_[L/R] from Signal Description table.
			Added RESP_[ULC/URC] to Signal Description table.
			Added notes 1 and 2 to Signal Description table.
			Changed number of NCs to 28.
			Changed number of SERDES (signal + power supply) to 74.
			Removed RESP balls from NC list (B2, C2, B29, C29).
			Added note to VTT table.
			Changed RxRefclk (B2 and C2) to NC.
			Added RESP_ULC.
			Added RESP_URC.
			Changed RxRefclk (B29 and C29) to NC.
June 2006	01.2	Introduction	Changed SERDES min bandwidth from 622 Mbps to 600 Mbps.
			Changed max SERDES bandwidth from 3.4 Gbps to 3.8 Gbps.
			Corrected number of package I/Os for the SC80 and SC115 1704 pin packages.
			Updated speed performance for typical functions with ispLEVER 6.0 values.
		Architecture	Changed “When these pins are not used they should be left unconnected.” with “Unused VTT pins should be connected to GND if the internal or external VCMT function is not used in the bank. If the internal or external VCMT function for differential input termination is used, the VTT pins should be unconnected and allowed to float.”
			Added “SERDES Power Supply Sequencing Requirements” section.
			Changed total bandwidth per quad from 13.6 Gbps to 15.2 Gbps.
			Added the accuracy of the temperature-sensing diode to be typically +/- 10 °C. Also referred to a temperature-sensing diode application note for more information.
		DC and Switching Characteristics	Changed “CTAP” to “internal or external VCMT”.
			Changed VCC12 parameter to include VDDP, VDDTX and VDDRX.
			Changed typical values to match ispLEVER 6.0 Power Calculator.

Date	Version	Section	Change Summary
August 2006 (cont.)	01.3 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Family Timing Adders with ispLEVER 6.0 SP1 results
			Updated PLL Timing Parameters based on PDE testing results
			Removed RDDATA parameter from sysCONFIG readback timing table
		Multiple	Changed TDO/RDDATA to TDO
		Pinout Information	Removed all MPI signals from SC15 256 pin package Dual Function Column
			Added note to SC15, SC25 900 pin package that the package supports a 16 bit MPI
			Added note that pin D3 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note that pin D28 in an SC15 and SC25 900 pin package should not be used for single-ended outputs
			Added note to SC25 1020 pin package that the package supports a 16 bit MPI
			Added note to SC80 1152 pin package that the package supports a 32 bit MPI
			Added note to SC80 1704 pin package that the package supports a 32 bit MPI
		Ordering Information	Changed “fcBGA” for the 1020 packages to “ffBGA”
November 2006	01.4	Introduction	LatticeSC Family Selection Guide table – I/O count for SC80 device, 1704 fcBGA package changed to 904/32. I/O count for SC115 device, 1704 fcBGA package changed to 942/32.
		DC and Switching Characteristics	DC Electrical Characteristics table – Updated the initialization and standby supply current values.
			DC Electrical Characteristics table – Updated the sysCONFIG Master Parallel mode RCLK low and RCLK high time specifications.
			DC Electrical Characteristics table – Updated VCCIO values for LVPECL33 I/Os.
		Pin Information	Pin Information Summary table - Changed number of single ended user I/Os from 906 to 904 for 1704 fcBGA.
			Removed the single-ended only output restriction on pins D3 and D28 in an SC15 and SC25 900 pin package.
		Ordering Information	Ordering Information tables - Changed number of I/Os from 906 to 904 for 1704 fcBGA.
			Added ordering part numbers for LatticeSC/SCM 40K and 115K LUT devices.
			Added lead-free ordering part numbers.
		Multiple	Changed number of available SC80 I/O from 906 to 904.
			Changed number of available SC115 I/O from 944 to 942.
January 2007	01.4a	Architecture	Added EBR Asynchronous Reset section.
February 2007	01.4b	Architecture	Updated EBR Asynchronous Reset section.
March 2007	01.5	Architecture	Added EBR asynchronous reset clarification
			Clarified that differential drivers are not supported in banks 1, 4 and 5
		DC and Switching Characteristics	Added clarification for the description of the junction temperature specification in the Absolute Maximum Ratings section.
			Updated Initialization and Standby Current table.
			Updated LatticeSC External Switching Characteristics with ispLEVER 6.1 SP1 results.